

ICMSET 2021

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2021 10th International Conference
on Material Science and Engineering
Technology (ICMSET 2021) will be
held in Kyoto, Japan during October
14-17, 2021.



CONFERENCE COMMITTEES

Conference Chair

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Technology of China

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Russia

PROCEEDINGS

Full papers accepted will be published by Materials Science
Forum ,(ISSN print 0255-5476 / ISSN web 1662-9752) Indexed
by Elsevier: SCOPUS, Ei Compendex (CPX).

ICMSET 2020 - Materials Science Forum(MSF) Vol. 1023,
ISBN: 978-3-0357-1784-6

ICMSET 2019 - Materials Science Forum(MSF) Vol. 998,
ISBN: 978-3-0357-1606-1.

ICMSET 2018 - Materials Science Forum(MSF) Vol. 950,
ISBN: 978-3-0357-1539-2.

ICMSET 2017 - Materials Science Forum(MSF) Vol. 917,
ISBN: 978-3-0357-1213-1.

ICMSET 2016 - Materials Science Forum(MSF) Vol. 890,
ISBN: 978-3-0357-1028-1.

Papers of ICMSET2015~ICMSET2020 are indexed by Ei
Compendex and Scopus!

CONTACT INFORMATION

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IMPORTANT DATES

- Submission Deadline: July 10, 2021
- Notification date: July 30, 2021
- Registration deadline: August 15, 2021

SUBMISSION METHOD

Please submit your full paper or Abstract
to the [Electronic Submission System](#);
Or submit via icmset@saise.org

CALL FOR PAPERS

Topics of interest for submission include, but are not limited to:

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|---|--|
| (01) Materials behavior | (07) Materials forming |
| (02) Casting and solidification | (08) Machining |
| (03) Powder metallurgy and ceramic forming | (09) Nanomaterials and nanomanufacturing |
| (04) Surface, subsurface, and interface phenomena | (10) Biomedical manufacturing |
| (05) Coatings and surface engineering | (11) Environmentally sustainable manufacturing processes and systems |
| (06) Composite materials | (12) Manufacturing process planning and scheduling |

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